



ZXTN25060BZQ

60V NPN MEDIUM POWER TRANSISTOR IN SOT89

Description

This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirements of automotive applications.

Features

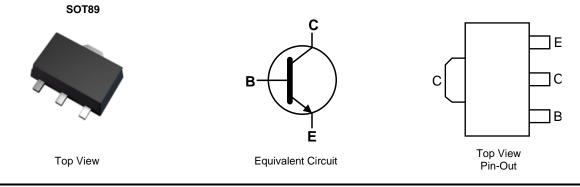
- BV_{CEX} > 150V
- BV_{CEO} > 60V
- BV_{ECO} > 6V
- I_C = 5A Continuous Collector Current
- V_{CE(sat)} < 70mV @ 1A
- $R_{CE(sat)} = 48m\Omega$ for a Low Equivalent On-Resistance
- Very Low Saturation Voltages
- Excellent hFE Characteristics
- 6V Reverse Blocking Capability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.055 grams (Approximate)

Applications

- Motor Driving (including DC fans)
- Solenoid, Relay and Actuator Drivers
- DC-DC Modules
- Power Switches
- MOSFET Gate Drivers



Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN25060BZQTA	Automotive	1C7	7	12mm	1,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

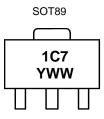
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.

3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



1C7= Product Type Marking Code YWW = Date Code Marking Y = Last Digit of Year (ex: 5 = 2015) WW = Week Code (01 ~ 53)



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	150	V
Collector-Emitter Voltage (Forward Blocking)	V _{CEX}	150	V
Collector-Emitter Voltage	V _{CEO}	60	V
Emitter-Collector Voltage (Reverse Blocking)	V _{ECO}	6	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	lc	5	A
Base Current	IB	1	A
Peak Pulse Current	I _{CM}	10	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 6)		1.1		
Power Dissinction	(Note 7)		1.8	W	
Power Dissipation	(Note 8)	P _D	2.4		
	(Note 9)	-	4.46		
	(Note 6)		117		
Thermal Desistance Innetion to Ambient Air	(Note 7)		68		
Thermal Resistance, Junction to Ambient Air	(Note 8)	R _{θJA}	51	°C/W	
	(Note 9)	-	28		
Thermal Resistance, Junction to Lead	(Note 10)	R _{θJL}	8]	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 11)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 6. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

7. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.

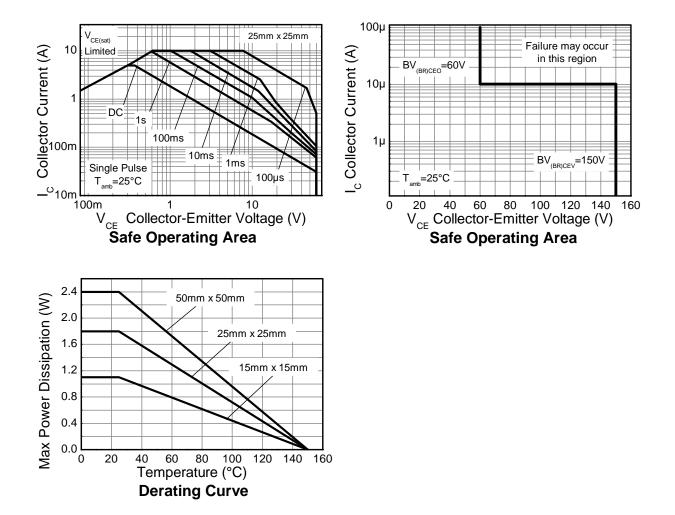
8. Same as Note 5, except the device is mounted on 50mm x 50mm 2oz copper.

9. Same as Note 7 measured at t<5 seconds.

Thermal resistance from junction to solder-point (on the exposed collector pad).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.

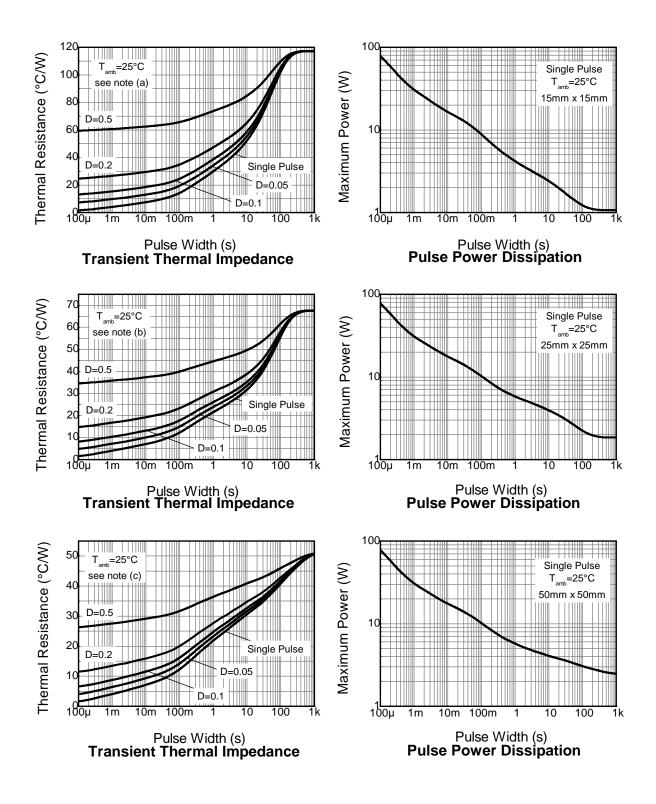


Thermal Characteristics and Derating Information





Thermal Characteristics and Derating Information (continued)





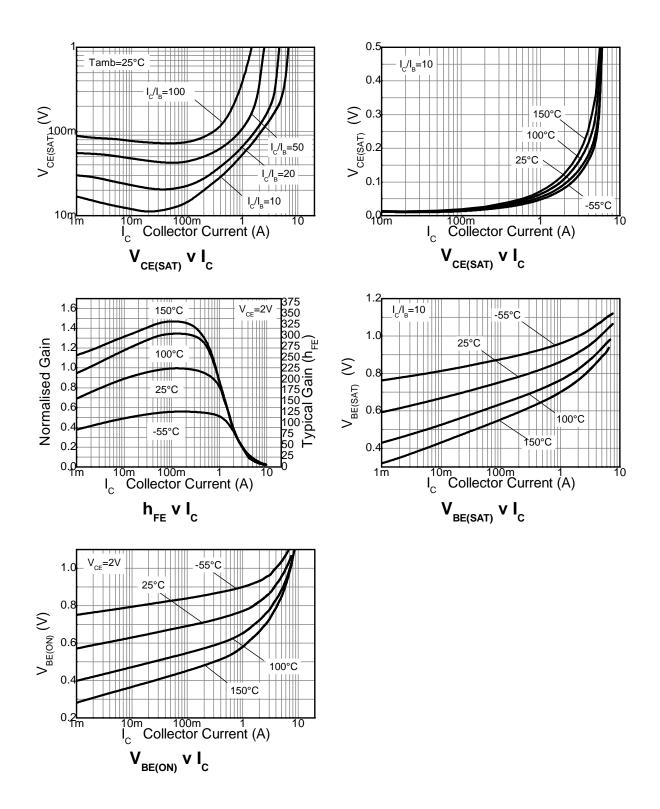
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Collector-Base Breakdown Voltage	BV _{CBO}	150	190	—	V	I _C = 100μA	
Collector-Emitter Breakdown Voltage (Forward Blocking)	BV _{CEX}	150	190	—	V	$I_C = 100 \mu A, R_{BE} \leq 1 k\Omega \text{ or} \\ -1 V < V_{BE} < 0.25 V$	
Collector-Emitter Breakdown Voltage (Note 12)	BV _{CEO}	60	80	—	V	$I_{\rm C} = 10 {\rm mA}$	
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.0	—	V	I _E = 100μΑ	
Emitter-Collector Breakdown Voltage (Reverse Blocking)	BV _{ECX}	6	8	—	V	$I_E = 100\mu$ A, R _{BC} \leq 1kΩ or <0.25V > V _{BC} >0.25V	
Emitter-Collector Breakdown Voltage (Base Open)	BV _{ECO}	6	7	—	V	I _E = 100μΑ	
Collector-Base Cutoff Current	Ісво	—	<1	50 20	nA μA	V _{CB} = 120V V _{CB} = 120V, T _A = +100°C	
Collector-Emitter Cutoff Current	ICEX	_	_	100	nA	V_{CE} = 120V, $R_{BE} \leq 1k\Omega$ or -1V < $V_{BE} < 0.25V$	
Emitter-Base Cutoff Current	I _{EBO}	—	<1	50	nA	V _{EB} = 5.6V	
Collector-Emitter Saturation Voltage (Note 12)	V _{CE(sat)}	_	55 70 185 240	70 90 230 305	mV	$\label{eq:lc} \begin{split} I_{C} &= 1A, \ I_{B} = 100 mA \\ I_{C} &= 1A, \ I_{B} = 50 mA \\ I_{C} &= 4A, \ I_{B} = 400 mA \\ I_{C} &= 5A, \ I_{B} = 500 mA \end{split}$	
Base-Emitter Saturation Voltage (Note 12)	V _{BE(sat)}	_	1,020	1,100	mV	$I_{C} = 5A, I_{B} = 500mA$	
Base-Emitter Turn-On Voltage (Note 12)	V _{BE(on)}	—	960	1,050	mV	$I_{C} = 5A, V_{CE} = 2V$	
DC Current Gain (Note 12)	hfe	100 90 45 —	200 180 90 20	300 — — —	_	$\label{eq:lc} \begin{array}{l} I_{C} = 10 m A, \ V_{CE} = 2 V \\ I_{C} = 1 A, \ V_{CE} = 2 V \\ I_{C} = 2 A, \ V_{CE} = 5 0 V \\ I_{C} = 5 A, \ V_{CE} = 5 V \end{array}$	
Transitional Frequency	f⊤	—	185	—	MHz	I _C = 100mA, V _{CE} = 5V f=100MHz	
Output Capacitance	Cobo	—	11.5	20	pF	V _{CB} = 10V, f=1MHz	
Delay Time	t _d	—	16	—	ns		
Rise Time	tr	_	15	—	ns	$V_{\rm CC} = 10V,$	
Storage Time	ts	_	509	_	ns	$I_{CC} = 500 \text{mA}$ $I_{B1} = -I_{B2} = 50 \text{mA}$	
Fall Time	t _f	_	57	—	ns	$-1B_1 - 1B_2 = 5000A$	

Note: 12. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



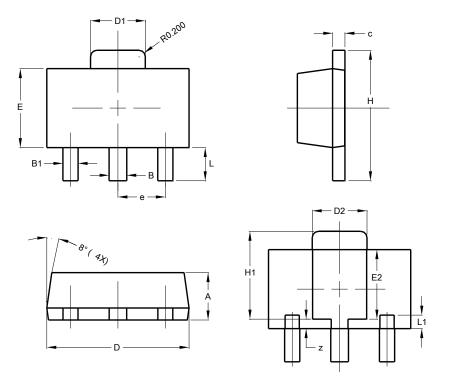
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





Package Outline Dimensions

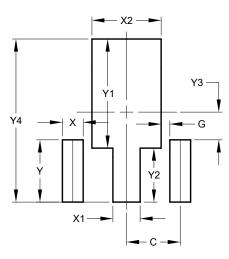
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	-	-	1.50		
н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
z	0.20	0.40	0.30		
All	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Y	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

- 1. are intended to implant into the body, or
- 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2015, Diodes Incorporated

www.diodes.com

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达迩科技(美台))